

SUPPORTING INFORMATION

Hybrid MoS₂/h-BN Nanofillers As Synergic Heat Dissipation and Reinforcement Additives in Epoxy Nanocomposites

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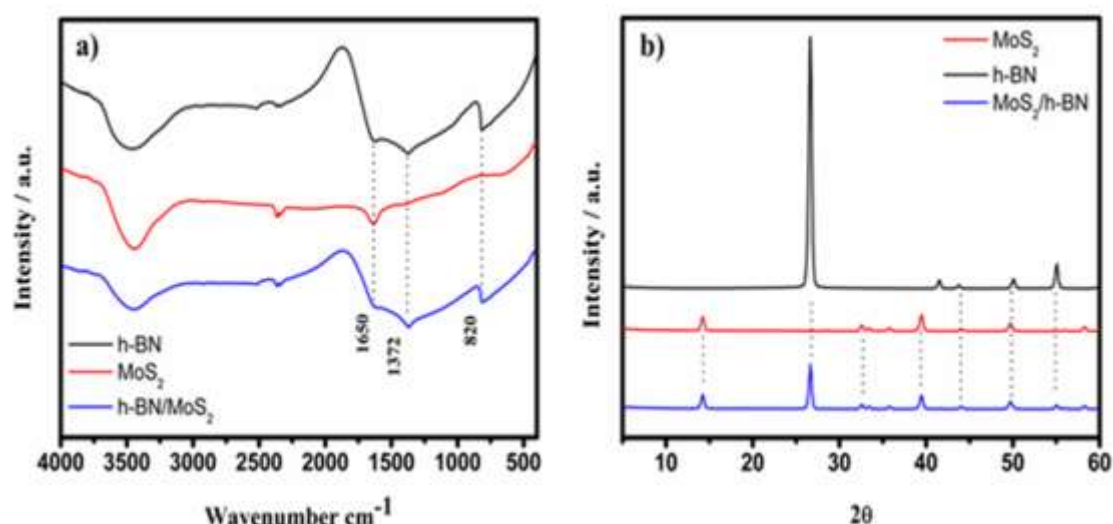


Figure S1. (a) FTIR spectra and (b) XRD patterns of MoS_2 , h-BN and hybrid $\text{MoS}_2/\text{h-BN}$ material. The dash lines indicate the correspondence in the signals for the hybrid composite and the pure nanomaterials.

The FTIR spectra of h-BN, MoS_2 , and mixture of h-BN/ MoS_2 (Figure S1a), show the main characteristic peaks, which are considered fingerprints of sp^2 bonds of h-BN: at 1372 cm^{-1} corresponding to the in-plane B–N transverse stretching and 820 cm^{-1} corresponding to the out-of-plane B–N–B bending vibration.¹ The broad band around $\sim 3428 \text{ cm}^{-1}$ can be attributed by the residual bonded N–H or caused to the water molecules absorbed on the surface of the samples.^{1–4} The vibrational modes at ~ 3435 and 1650 cm^{-1} are assigned to hydroxyl functionalities of adsorbed moisture on the MoS_2 nanosheets.⁵

The XRD patterns of h-BN, MoS_2 , and mixture of h-BN/ MoS_2 are shown in Figure S1b. The intense diffraction peak $2\theta \sim 26.76^\circ$, (002) plane, denote the high crystallinity of the h-BN nanostructure.¹ MoS_2 showed characteristic peaks at 2θ of $12.00^\circ, 32.00^\circ, 40.00^\circ,$ and 50.01° due to diffraction from (002), (100), (103), and (105) planes, respectively.⁵

The diffraction pattern was found to be fully matched with JCPDS file 37-1492. The sample of the heterostructure h-BN/MoS₂ showed peaks corresponding to both h-BN and MoS₂ separated samples.

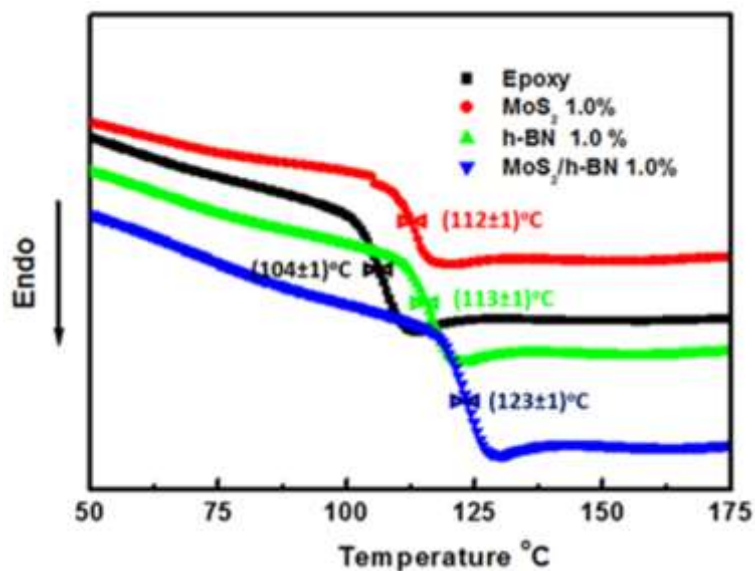


Figure S2. DSC curves of neat epoxy and composites containing 1.0 wt.% of MoS₂, h-BN and hybrid MoS₂/h-BN.

DSC curves for pure epoxy and the composites containing 1.0 wt% of MoS₂, h-BN and MoS₂/h-BN in the second heating scan are shown in Figure S2. The glass transition temperature (T_g) was determined from the midpoints of three measurements (average values) for each sample. The T_g values showed standard deviation of $\pm 1^\circ\text{C}$. Increases in T_g values for all systems were observed, however, the system containing 1.0 wt % of MoS₂/h-BN showed the best increase of up to 19°C when compared to pure polymer. Generally, in epoxy systems the increase of the glass transition temperature is associated with restriction of the mobility of their polymer chains due to a high degree of cross-link and reduction of free volume.⁶ Factors that affect the value of T_g for epoxy nanocomposites include: the degree of dispersion of the nanofillers, interaction between

nanofillers/polymer and curing process conditions. Under the conditions studied here, it can be said that the cross-linking process was not affected by the addition of nanofillers, i.e., the polymer chains were not generated with free ends as observed by other authors.⁷ Moreover, it is possible that the interface between the introduced MoS₂ and h-BN served as chemical anchor points for epoxy chains, thus impacting the mobility thereof and increasing the T_g values in the hydride composite.

Table S1. Storage modulus, T_g and cross-link density values of neat epoxy and nanocomposites with different wt% of 2D nanofiller

System (wt%)	Storage Modulus at T_g (MPa)	T_g (°C) ±1	Cross-link Density (mol cm⁻³)
Neat epoxy	1662±13	123	0.5056±0,0011
MoS ₂ 0.25	1642±11	125	0.5289±0,0015
MoS ₂ 0.50	1725±21	126	0.5312±0,0008
MoS ₂ 1.0	1738±19	126	0.5828±0.0014
h-BN 0.25	1613±22	127	0.5013±0.0013
h-BN 0.50	1645±27	128	0.5343±0.0010
h-BN 1.0	1637±29	130	0.6371±0.0011
MoS ₂ / h-BN 0.25	2627±22	131	0.5917±0.0014
MoS ₂ / h-BN 0.50	2674±26	133	0.6273±0.0012
MoS ₂ / h-BN 1.0	2777±18	135	0.7183±0.0013

The values of brittleness (B) for viscoelastic materials enables the comparative analysis of several types of polymer-based materials, metal, alloys, ceramics and glasses.⁸ The parameters obtained from tensile testing can be connected with the brittleness through the equation proposed by Brostow and Narkis.⁹

$$B = 1/(\epsilon_b E') \quad (2)$$

where ϵ_b is the tensile elongation at break, and E' is the storage modulus determined by DMA test at 1 Hz, both at same temperature.⁸⁻¹⁰ The numerical values of storage modulus, tensile elongation and brittleness at 25°C for neat epoxy and nanocomposites are shown in Table S2.

Table S2. Storage modulus (E'), tensile elongation at break (ϵ_b), and brittleness (B) values of neat epoxy and nanocomposites with different wt% of 2D nanofiller at 25°C

System (wt%)	E' (Pa)/10 ⁸	ϵ_b (%)	B (%Pa/10 ¹⁰)
Neat epoxy	44.49± 09	15.28	0.147
MoS ₂ 0.25	46.72± 11	18.69	0.115
MoS ₂ 0.50	46.35±13	20.27	0.106
MoS ₂ 1.0	44.25±15	19.38	0.116
h-BN 0.25	48.28±07	19.83	0.104
h-BN 0.50	49.54±17	19.85	0.102
h-BN 1.0	50.21±14	17.56	0.113
MoS ₂ / h-BN 0.25	56.68± 10	18.33	0.093
MoS ₂ / h-BN 0.50	55.24±15	21.76	0.081
MoS ₂ / h-BN 1.0	59.97±12	23.25	0.074

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